

1.5V Drive Pch MOSFET

RZR020P01

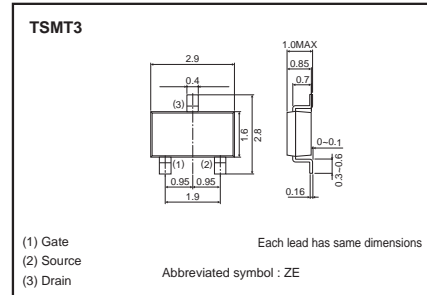
●Structure

Silicon P-channel MOSFET

●Features

- 1) Low on-resistance.
- 2) Built-in G-S Protection Diode.
- 3) Small and Surface Mount Package (TSMT3).
- 4) Low voltage drive (1.5V).

●Dimensions (Unit : mm)



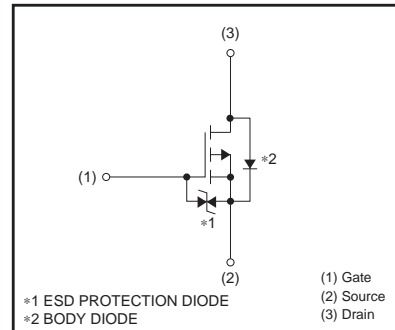
●Applications

Switching

●Packaging specifications

Type	Package	Taping
	Code	TL
	Basic ordering unit (pieces)	3000
RZR020P01		○

●Inner circuit



●Absolute maximum ratings (Ta=25°C)

Parameter	Symbol	Limits	Unit
Drain-source voltage	V_{DS}	-12	V
Gate-source voltage	V_{GS}	± 10	V
Drain current	Continuous	I_D	± 2 A
	Pulsed	I_{DP} *1	± 6 A
Source current (Body diode)	Continuous	I_S	-0.8 A
	Pulsed	I_{SP} *1	-6 A
Total power dissipation	P_D *2	1.0	W
Channel temperature	T_{ch}	150	°C
Range of storage temperature	T_{stg}	-55 to +150	°C

*1 $P_w \leq 10 \mu s$, Duty cycle $\leq 1\%$

*2 When mounted on a ceramic board.

●Thermal resistance

Parameter	Symbol	Limits	Unit
Channel to ambient	$R_{th}(ch-a)$ *	125	°C / W

* When mounted on a ceramic board.

●Electrical characteristics (Ta=25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Gate-source leakage	I _{GSS}	–	–	±10	μA	V _{GS} =±10V, V _{DS} =0V
Drain-source breakdown voltage	V _{(BR)DSS}	–12	–	–	V	I _D = –1mA, V _{GS} =0V
Zero gate voltage drain current	I _{DSS}	–	–	–1	μA	V _{DS} = –12V, V _{GS} =0V
Gate threshold voltage	V _{GS(th)}	–0.3	–	–1.0	V	V _{DS} = –6V, I _D = –1mA
Static drain-source on-state resistance	R _{DS(on)*}	–	75	105	mΩ	I _D = –2A, V _{GS} = –4.5V
		–	105	145	mΩ	I _D = –1A, V _{GS} = –2.5V
		–	150	225	mΩ	I _D = –1A, V _{GS} = –1.8V
		–	200	400	mΩ	I _D = –0.4A, V _{GS} = –1.5V
Forward transfer admittance	Y _{fs} *	2	–	–	S	V _{DS} = –6V, I _D = –2A
Input capacitance	C _{iss}	–	770	–	pF	V _{DS} = –6V
Output capacitance	C _{oss}	–	75	–	pF	V _{GS} =0V
Reverse transfer capacitance	C _{rss}	–	60	–	pF	f=1MHz
Turn-on delay time	t _{d(on)*}	–	10	–	ns	V _{DD} ≐ –6V
Rise time	t _r *	–	17	–	ns	I _D = –1A
Turn-off delay time	t _{d(off)*}	–	65	–	ns	V _{GS} = –4.5V
Fall time	t _f *	–	35	–	ns	R _L ≐ 6Ω
Total gate charge	Q _g *	–	6.5	–	nC	R _G =10Ω
Gate-source charge	Q _{gs} *	–	1.3	–	nC	V _{DD} ≐ –6V, I _D = –2A
Gate-drain charge	Q _{gd} *	–	0.8	–	nC	V _{GS} = –4.5V
						R _L ≐ 3Ω, R _G =10Ω

* Pulsed

●Body diode characteristics (Source-drain) (Ta=25°C)

Parameter	Symbol	Min.	Typ.	Max.	Unit	Conditions
Forward voltage	V _{SD} *	–	–	–1.2	V	I _S = –2A, V _{GS} =0V

* Pulsed

●Electrical characteristics curves

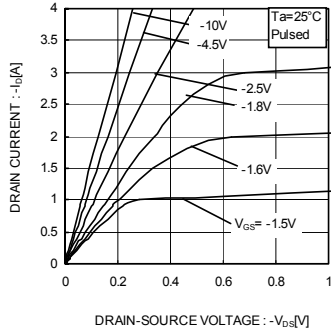


Fig.1 Typical Output Characteristics (I)

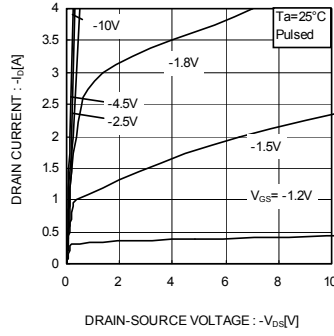


Fig.2 Typical Output Characteristics (II)

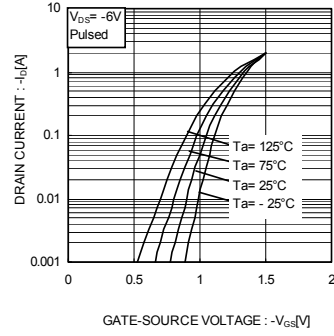


Fig.3 Typical Transfer Characteristics

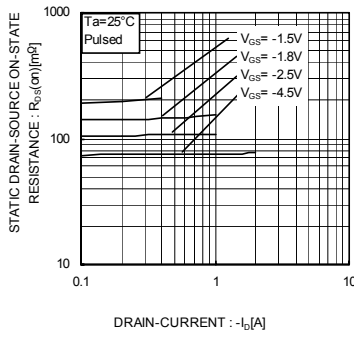


Fig.4 Static Drain-Source On-State Resistance vs. Drain Current (I)

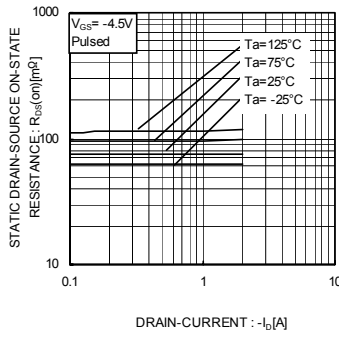


Fig.5 Static Drain-Source On-State Resistance vs. Drain Current (II)

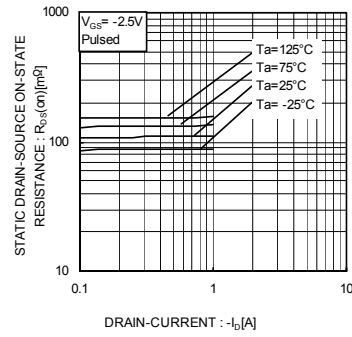


Fig.6 Static Drain-Source On-State Resistance vs. Drain Current (III)

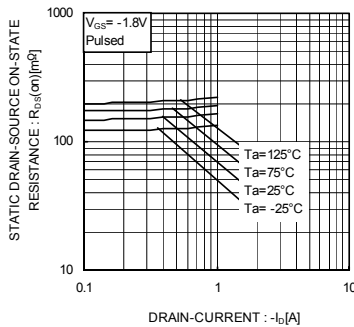


Fig.7 Static Drain-Source On-State Resistance vs. Drain Current (IV)

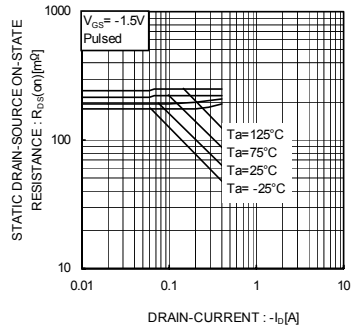


Fig.8 Static Drain-Source On-State Resistance vs. Drain Current (V)

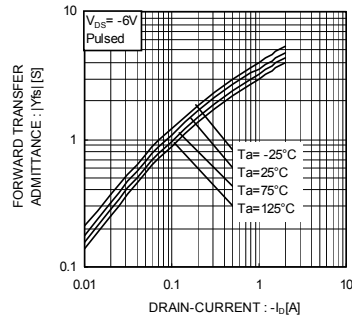


Fig.9 Forward Transfer Admittance vs. Drain Current

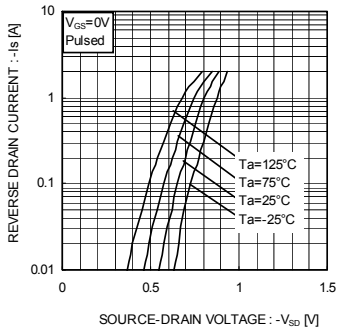


Fig.10 Reverse Drain Current vs. Source-Drain Voltage

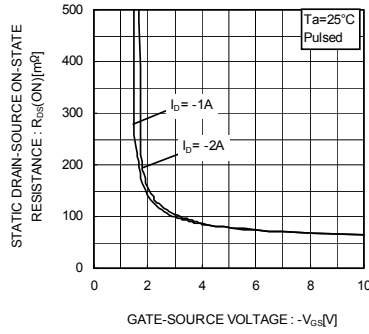


Fig.11 Static Drain-Source On-State Resistance vs. Gate Source Voltage

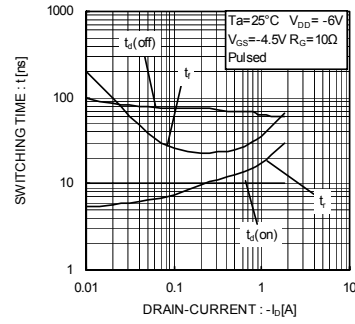


Fig.12 Switching Characteristics

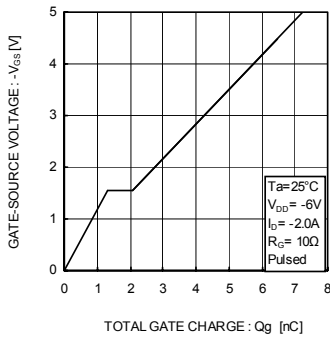


Fig.13 Dynamic Input Characteristics

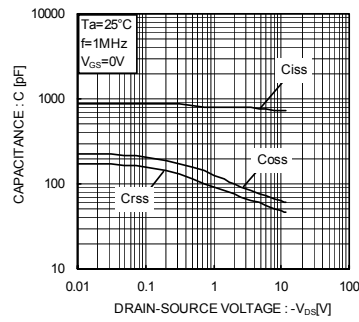


Fig.14 Typical Capacitance vs. Drain-Source Voltage

●Measurement circuit

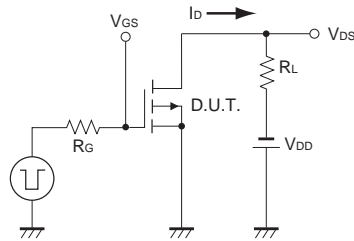


Fig.1-1 Switching Time Measurement Circuit

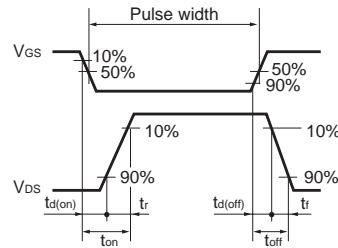


Fig.1-2 Switching Waveforms

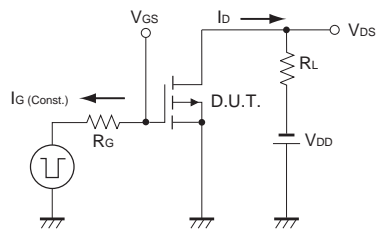


Fig.2-1 Gate Charge Measurement Circuit

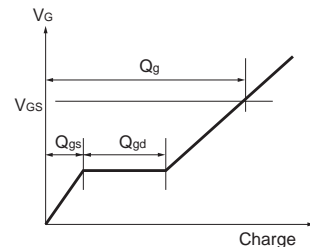


Fig.2-2 Gate Charge Waveform

●Notice

This product might cause chip aging and breakdown under the large electrified environment. Please consider to design ESD protection circuit.

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